

SFP-560A3C-FA

Platform Polisher for Factory Automation



■ Features / Benefits

SFP-560A3C-FA has three key features necessary for FA machine to automate polishing

- Auto fixture clamping
- Turntable origin position return
- Network connection to command operation from external machine

Seikoh Giken provides necessary address info for engineers to send command from their own FA machine to operate SFP-560A3C-FA

Having same features as SFP-560A3C for standalone use

- Consumables info manageable Entry of Film, Pad, Liquid
- Repolishing time entry setting for any steps you are in
- Pressure ramp-up and Fixed Height Mode available for all polishing step
- Wider speed adjustment range : 10- 200 rpm
- And more features to make polishing more efficient and convenient !



■ Specifications

Weight	22kg (48.5lb)
Dimensions	240W x 370D x 305H (mm)
Polishing Method	Rotation & Revolution
Pressure Control	2N to 200N in DPC mode
Power	100~ 240 VAC, 50/60Hz
Required Air	0.6MPa to 0.8MPa
Motor speed	Revolution: 10 to 200rpm Rotation: 1/100 of rev. speed
Process storage	48 processes
Safety	Wired emergency stop circuit
Protocol	Modbus TCP/IP

~DPC : Dynamic Pressure Control~
(Patent Pending)



High Volume, Multi-Axis
Intelligent Automation
Superior MT Geo.